

Attorney Docket No.: 071469-0305914

Client Reference No.: RAJ-007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Confirmation No.: 7364

TSUKASA MATSUDA et al.

Group Art Unit: 1762

Appln. No.: 10/673,910

Examiner: STOUFFER, Kelly M.

Filed: September 30, 2003

FOR: METHOD FOR DEPOSITING METAL LAYERS USING SEQUENTIAL FLOW
DEPOSITION

May 25, 2007

AMENDMENT

Mail Stop Amendment
United States Patent and Trademark Office
Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the Final Office Action dated March 20, 2007, please amend the above-captioned patent application as follows:

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